



Product Change Notification

Change Notification #: 118112 - 00
Change Title: MINOR CHANGE: Changes Regarding Thermal Form Tray (TFT), PCN 118112-00, Transport Media, Adding Human Readable Identifier & Adding Post-Consumer Recycled Plastic into the Composition of Trays
Date of Publication: March 9, 2021

Key Characteristics of the Change:
Label, Transport Media

Forecasted Key Milestones:

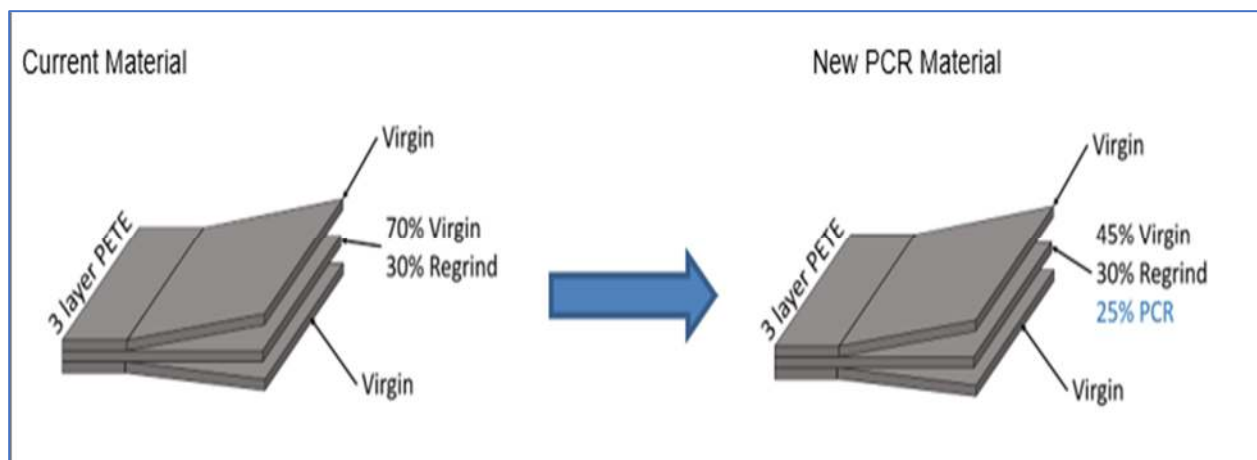
Date Customer Must be Ready to Receive Post-Conversion Material:	September 25, 2021
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Description of Change to the Customer:

As a part of Intel's "Green It!" initiative as well as for continuous improvement, Intel will be making the following two changes impacting all Thermal Form Trays (TFT):

- 1) Adding Post-Consumer Recycled Plastic into the composition of the Thermal Form Tray (TFT).

The "Center" layer of the PETE material used to create the TFTs will contain 25% of Post-Consumer Recycled (PCR) plastic material. The center layer is 80% of the total thickness of the PETE sheet.



- 2) Adding two characters to the end of the Human Readable tray serial number to identify the material sub supplier for Intel's Tray Manufacturer and the material content.



Customer Impact of Change and Recommended Action:

Intel classifies these changes as Minor Changes. There is no change to the Form, Fit, Function, Quality or Reliability of the products as a result of this change.

Intel will continue to ship and use older trays until the older tray inventory is depleted. Therefore, customers should expect to see a mixture of trays used for several months or more.

Please contact your local Intel representative with any questions or concerns regarding the changes communicated in this notification.

Products Affected / Intel Ordering Codes:

The products impacted by these changes are too numerous to list and therefore the attached Excel list of impacted SKUs should suffice. Please reference the attached .xls spreadsheet containing the list of impacted products.

PCN Revision History:

Date of Revision:
March 9, 2021

Revision Number:
00

Reason:
Originally Published PCN



Product Change Notification

118112 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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